

## **SMT Inductor**

Product Class:		SIMID 2220-A/H B82442A/H1****050									
				102K							
		09.07.2013									
IMDS ID											
if available											
Version: 02											
Product Part (IMDS: semi component)		terial Class Material DS: Material) (Classification) VDA 231		Substance			TMPS**) [wt%]	CAS if applicable	typical mass of material [wt-%]	Traces see 1)	
Active Part	Ceramic		4B	Nickel Zinc Ferrite		100	12645-50-0	36.8			
	Heavy N	letal	1C	Cu		100	7440-50-8	16.1			
	Elastomer		2B	Polyurethane (PUR)		100	68400-67-9	0.1			
Encapsulation	Thermoplastic		2A	Liquid Crystal Polymer (LCP)			70	147310-94-9	38.7		
and Mounting				Glass fiber	۶ſ			65997-17-3	30.7		
•	Durome	r	2C	Epoxy (EP)			100	25068-38-6	1.1		
Termination	Line of Martal		1C	Cu	Cu 94 7440-5				6.4		
	Heavy N	letal	1C	Sn			6	7440-31-5	6.4		
	Heavy N	letal	1C	Ni			100	7440-02-0	0.2		
Heavy M		letal	1C	Sn			100	7440-31-5	0.6		
								Sum in total:	100.0		
[max. in mm] 5.9 x 5.3 x 5.3	0	B824	442A1****050 442H1****050								
Not part of a Pr					1	entent versentre.					
	Dr. Johann Reindl, EPQM				Important remarks:						
	TDK Electronics AG, Magnetics Business Group (MAG) Rosenheimer Strasse 116b, 81669 Munich					<ol> <li>The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906) Traces are product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise regulated</li> <li>This Material Data Sheet contains typical values of the respective products set forth</li> </ol>					
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*) others: .(not declarable or prohibited substances acc. GADSL)					herein. We expressly point out that all values and statements contained herein are based on our best present knowledge and cannot be regarded as binding statements						
, (		•	ances acc. GADSL	-)		or binding product specif	fications, unle	ss otherwise explicit	ly agreed in writi	ng. TDK	
**) typical mass				ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE.							
						oducts are compatible with striction of the use of certain					
RoHS - Exempt	tions for t	he Product Class	/ Product accord	ing to Annex III: (	( ⊠ va	alid 🛛 not valid )					
<ul> <li>no exemptions;</li> <li>Exemption 6 (a):</li> <li>Exemption 6 (b):</li> <li>Exemption 6 (c):</li> </ul>	Lead as an	alloving element in steel	• •	•	containi	ing up to 0,35 % lead by weight	;				
	Copper allo Lead in high Electrical ar	alloying element in alum y containing up to 4 % le n melting temperature typ nd electronic component	ead by weight; pe solder (i.e. lead-based	alloys containing 85 % ss or ceramic other than	dielect	tric ceramic in capacitors, e.g. p	iezoelectronic d	evices, or in a glass or o	eramic matrix com	pound;	
Exemption 7 (c)-I:	Copper allo Lead in high Electrical ar Lead in diel : Lead in diel	alloying element in alum y containing up to 4 % le n melting temperature ty nd electronic component ectric ceramic in capacit ectric ceramic in capacit	ead by weight; pe solder (i.e. lead-based s containing lead in a gla: ors for a rated voltage of ors for a rated voltage of	alloys containing 85 % ss or ceramic other than 125 V AC or 250 V DC c less than 125 V AC or 2	or highe	tric ceramic in capacitors, e.g. p er;		-	eramic matrix com	pound;	